



## RoHS Compliance Statement

Spectrum Semiconductor Materials as a distributor of semiconductor assembly materials has verified that all ceramic package and lid sources certify their products are in compliance and conform to the European Union's Restriction of Use of Hazardous Substances in Electrical and Electronic Equipment (RoHS 3) Directive 2015/863/EC.

All semiconductor assembly materials supplied by Spectrum Semiconductor Materials will have less than the RoHS limits as stated below for the seven restricted use substances. This Declaration is based on our vendor supplied analysis or material certifications.

Lead (Pb)	0.0wt%
Mercury (Hg)	0.0wt%
Cadmium (Cd)	0.0wt%
Hexavalent Chromium: (Cr VI)	0.0wt%
Polybrominated Biphenyls (PBB)	0.0wt%
Polybrominated Diphenyl Ethers (PBDE)	0.0wt%
Bis(2-Ethylhexyl) phthalate (DEHP)	0.0wt%
Benzyl butyl phthalate (BBP)	0.0wt%
Dibutyl phthalate (DBP)	0.0wt%
Diisobutyl phthalate (DIBP)	0.0wt%

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